

C1206X333J1GACTU

Aliases (C1206X333J1GAC7800) SMD Comm COG Flex, Ceramic, 0.033 uF, 5%, 100 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1206, 1.5 mm



General Information	
Series	SMD Comm COG Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra- Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	25 mg
Shelf Life	78 Weeks
MSL	1

0.033 uF

1 kHz 1.0Vrms

30.303 GOhms

Dimensions	
Chip Size	1206
L	3.3mm +/-0.4mm
W	1.6mm +/-0.35mm
Т	1.1mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm

W	1.6mm +/-0.35mm	Tolerance	5%
Т	1.1mm +/-0.20mm	Voltage DC	100 VDC
S	1.5mm MIN	Dielectric Withstanding Voltage	250 VDC
В	0.6mm +/-0.25mm	Temperature Range	-55/+125°C
		Temp. Coefficient	COG
Packaging Specifications		Capacitance Change with	30 ppm/C, 1kHz 1.0Vrms
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	., ,
Packaging Quantity	2500	Dissipation Factor	0.1% 1 kHz 1.0Vrms
		Aging Rate	0% Loss/Decade Hour

Specifications

Measurement Condition

Insulation Resistance

Capacitance

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Generated 05/04/2025 © 2006 - 2025 YAGEO